

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Robert S. Lewandowski et al. : Group Art Unit:

Serial No.: To Be Assigned : Examiner:

Filed: Concurrently

Title: METHOD AND MEANS FOR ISOLATING  
ELEMENTS OF A SENSOR ARRAY

Hon. Commissioner of Patents & Trademarks  
Washington, D.C. 20231

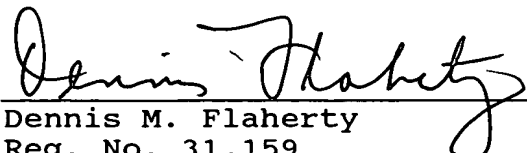
**INFORMATION DISCLOSURE STATEMENT**

Sir:

Pursuant to 37 CFR § 1.97, the Applicants hereby request that the references cited in the accompanying Form PTO-1449 be considered by the examiner in the above-entitled application and made of record therein. Copies of the cited references are submitted herewith.

Citation of the annexed documents shall not be construed as: (1) an admission that the documents are prior art with respect to the instant claimed invention; (2) a representation that a search has been made, other than as described above; or (3) an admission that the information cited herein is, or is deemed to be, material to patentability as defined in § 1.56(b).

Respectfully submitted,



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March 31, 2004  
Date

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**INFORMATION DISCLOSURE STATEMENT BY APPLICANT**

**U.S. PATENT DOCUMENTS**

EXAMINER INITIAL		PATENT NUMBER	ISSUE DATE	PATENTEE	CLASS	SUB- CLASS	FILING DATE
	A	6,262,946	7/17/01	Khuri-Yakub et al.	367	181	

**FOREIGN PATENT OR PUBLISHED FOREIGN PATENT APPLICATIONS**

EXAM- INER INITIAL		PUB. NUMBER	PUBLI- CATION DATE	COUNTRY OR PATENT OFFICE	CLASS	SUB- CLASS	TRANS- LATION	
							YES	NO

**OTHER DOCUMENTS**

(Including Author, Title, Date, Relevant Pages, Place of Publication)

	B	Roh and Khuri-Yakub, "Finite Element Analysis of Underwater Capacitor Micromachined Ultrasonic Transducers," IEEE Trans. Ultrasonics, Ferroelectrics, and Freq. Control, Vol. 49, No. 3, pp. 293-298, March 2002.
	C	Ladabaum et al., "Silicon Substrate Ringing in Microfabricated Ultrasonic Transducers," 2000 IEEE Ultrasonics Symposium.
	D	Oralkan et al., "Volumetric Imaging Using 2D Capacitive Micromachined Ultrasonic Transducer Arrays: Initial Results," 2002 IEEE Ultrasonics Symposium.

Examiner:	Date Considered:
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**EXAMINER:** Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.